

140 COMMERCE DRIVE MONTGOMERYVILLE, PA 18936-1013 PHONE: (215) 631-9840 FAX: (215) 631-9855

# MS2472

### **RF & MICROWAVE TRANSISTORS AVIONICS APPLICATIONS**

#### Features

- DESIGNED FOR HIGH POWER PULSED IFF AND DME APPLICATIONS
- 600 W (typ.) IFF 1030 1090 MHz
- 550 W (min.) DME 1025 1150 MHz
- 1025 1150 MHz
- **P**<sub>OUT</sub> = **550 WATTS**
- $G_P = 5.6 \text{ dB MINIMUM}$
- GOLD METALLIZATION
- INTERNAL INPUT/OUTPUT MATCHED
- COMMON BASE CONFIGURATION

# **DESCRIPTION:**

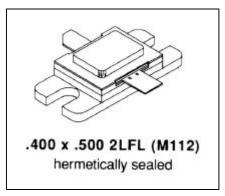
The MS2472 is a hermetically sealed, gold metallized, silicon NPN power transistor. The MS2472 is designed for applications requiring high peak power and low duty cycles such as IFF and DME. The MS2472 is internal input/output matched resulting in improved broadband performance and a low thermal resistance.

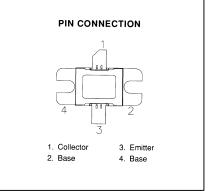
# ABSOLUTE MAXIMUM RATINGS (Tcase = 25°C)

Symbol	Parameter	Value	Unit
V <sub>сво</sub>	Collector-Base Voltage	65	V
V <sub>CES</sub>	Collector-Emitter Voltage	65	V
$V_{EBO}$	Emitter-Base Voltage	3.5	V
I <sub>C</sub>	Device Current	40	А
P <sub>DISS</sub>	Power Dissipation	1350	W
TJ	Junction Temperature	200	°C
T <sub>STG</sub>	Storage Temperature	-65 to +150	° C

## **Thermal Data**

R <sub>TH(J-C)</sub> Thermal Resistance Junction-case	0.06	°C/W
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MS2472

# ELECTRICAL SPECIFICATIONS (Tcase = 25°C) STATIC

Symbol		Test Conditions		Value		Unit	
		Test conditions	Min.	Тур.	Max.	Unit	
BV <sub>CBO</sub>	l <sub>c</sub> = 25 mA	I <sub>E</sub> = 0 mA	65			۷	
BV <sub>CES</sub>	I <sub>c</sub> = 50 mA	$V_E = 0 V$	65			V	
BV <sub>EBO</sub>	I <sub>c</sub> = 10 mA	I <sub>c</sub> = 0 mA	3.5			V	
I <sub>CES</sub>	V <sub>CE</sub> = 50 V	I <sub>E</sub> = 0 mA			35	mA	
H <sub>FE</sub>	V <sub>CE</sub> = 5 V	I <sub>C</sub> = 0.25 A	5		200		

### DYNAMIC

Symbol	Test Conditions		Value	y Unit		
Symbol	Symbol Test conditions		Тур.	Max.	Onit	
Ρουτ	$f = 1025 - 1150 MHz \qquad P_{IN} = 150 W \qquad V_{CE} = 50 V$	550			W	
G <sub>P</sub>	$f = 1025 - 1150MHz$ $P_{IN} = 150W$ $V_{CE} = 50V$	5.6			dB	

Conditions: Pulse Width =  $10 \ \mu s$  Duty Cycle = 1%

### **IMPEDANCE DATA**

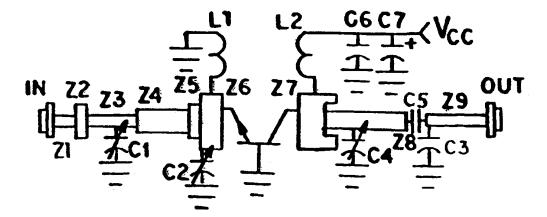
FREQ	$Z_{IN}(\Omega)$	$Z_{CL}(\Omega)$
1025 MHz	2.50 + j2.7	1.33 - j1.7
1090 MHz	2.60 + j1.6	1.33 - j1.9
1150 MHz	1.90+ j0.7	1.33 - j2.1

 $P_{IN} = 150W$  $V_{CC} = 50V$ 



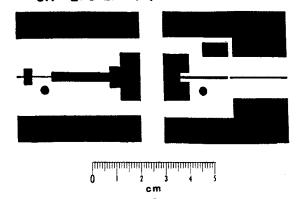
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### **TEST CIRCUIT**



All Dim	ensions are in inches Unless Otherwise Specified	Z1 Z2	:	50 <b>Ω</b> (.02 Wide) .250 x .120
C1 C2, C3	: 0.4 - 2.5pF Johanson Gigatrim	Z3 Z4		50Ω, .020 x .330; C1 Tapped .15 From Load .145 x .920
C4	. 0.6 - 4.5pF Johanson Gigatrim	Z5	:	.325 x .180
C5	: 82pF Chip Capacitor, .055 Sq.	Z6	:	.730 x .315
C6	: Pair of 820pF Chip Capacitors, .11 Sq.	<b>Z</b> 7	:	.710 x .425 with .140 x .150 Cutout
C7	: 1000µF Electrolytic	Z8	:	.035 x .780; C4 Tapped .36 from Center
		Z9	:	50Ω (.02 Wide)
L1	: Loop, #18 Tinned, .36 Wide x .27 Above Circuit			• •
L2	: 4 3/4 Turns, #24 Enameled, Close Wound: .075 I.D.	C1, C4	• :	Cold End Terminated Through Eyelet

3M EPSILAN 10, .032 THK., 102.

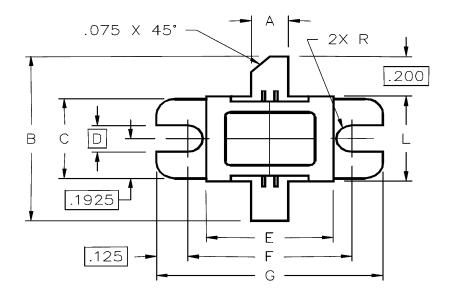


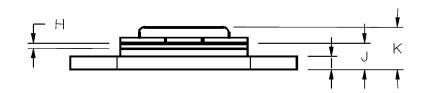


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### PACKAGE MECHANICAL DATA

### PACKAGE STYLE M112





	MINIMUM	MAXIMUM		MINIMUM	MAXIMUM
	INCHES/MM	INCHES/MM		INCHES/MM	INCHES/MM
Α	.145/3,68	.155/3,93		.055/1,40	.065/1,65
В	.750/19,05		J	.115/2,92	.135/3,43
С	.380/9,.65	.390/9,91	K		.230/5,64
D	.130/3,30		L	.395/10,03	.410/10,41
Ε	.495/12,57	.505/12,83			
F	.640/16,26	.655/16,64			
G	.890/22,61	.910/23,11			
Н	.002/0,05	.006/0,15			

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